

[illegible]

**INFORMATION DISCLOSURE CITATION**  
(Use several sheets if necessary)

Docket Number (Optional)  
**YKI-0077-C**

Application Number

Applicant(s)  
**Katsuya Anzai**

Filing Date

Group Art Unit

**U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
LP		5,897,328	04/27/1999	Yamauchi et al.			
		5,986,632	11/16/1999	Takayama et al.			
		6,326,249	12/04/2001	Yamazaki et al.			
		6,369,507	04/09/2002	Arai			
		6,420,200	07/16/2002	Yamazaki et al.			

**FOREIGN PATENT DOCUMENTS**

	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO

**OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, Etc.)

LP		Handbook of Multilevel Metallization for Integrated Circuits Materials, Technology, and Applications, Noyes Publications, Westwood, NJ, USA, 1993, pg 357, 386, and 389

EXAMINER

*Long Pham*

DATE CONSIDERED

*8/25/05*

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.